



**Product data sheet** 

## 1. General description

Ultrafast power diode in TO252 (DPAK) plastic package.

## 2. Features and benefits

- Low forward voltage drop
- Low leakage current
- Soft reverse recovery characteristics
- High thermal cycling performance

## 3. Applications

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- Home appliance power supply
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

## 4. Quick reference data

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Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage			6	00		V
$\mathbf{I}_{\mathrm{F(AV)}}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	10			A	
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 157 °C; square-wave pulse	20			A	
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	120 132		А		
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse			А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.07	1.3	V
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	0.92	1.1	V
Dynamic	characteristics	I					
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>i</sub> = 25 °C; <u>Fig. 6</u>		-	40	75	ns

## **5. Pinning information**

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode	2	
2	К	cathode [1]		ККА
3	А	anode		001aaa020
mb	К	mounting base; cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

## 6. Ordering information

Table 3. Ordering information							
Type number	Package	Orderable part number	Packing	Small packing	Package	Package	
	Name		method	quantity	version	issue date	
BYV10D-600P	TO252	BYV10D-600PJ	Reel	2500	TO252N	14-Nov-2016	

## 7. Marking

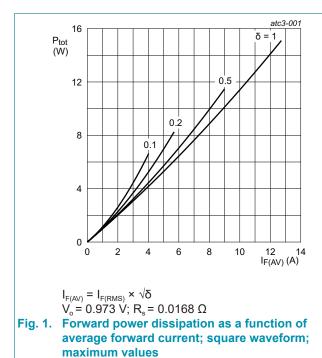
Table 4. Marking codes		
Type number	Marking codes	
BYV10D-600P	BYV10D	
	600P	

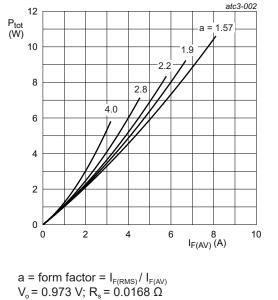
## 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

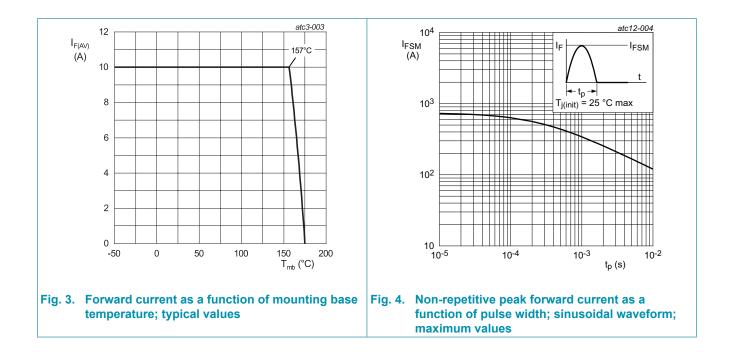
Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
V <sub>RWM</sub>	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	10	A
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 ; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 157 °C; square-wave pulse	20	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	120	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	132	A
T <sub>stg</sub>	storage temperature		-55 to 175	°C
T <sub>j</sub>	junction temperature		175	°C





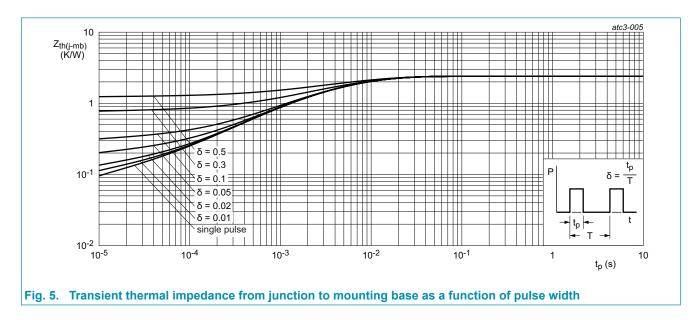
V<sub>o</sub> = 0.973 V; R<sub>s</sub> = 0.0168 Ω
 Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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## 9. Thermal characteristics

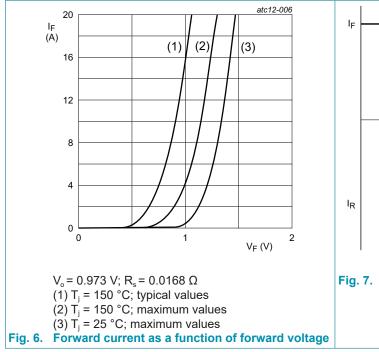
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

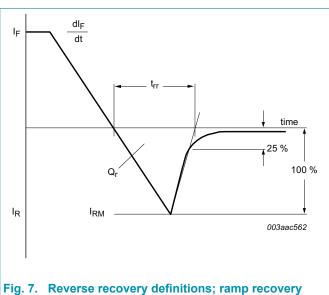


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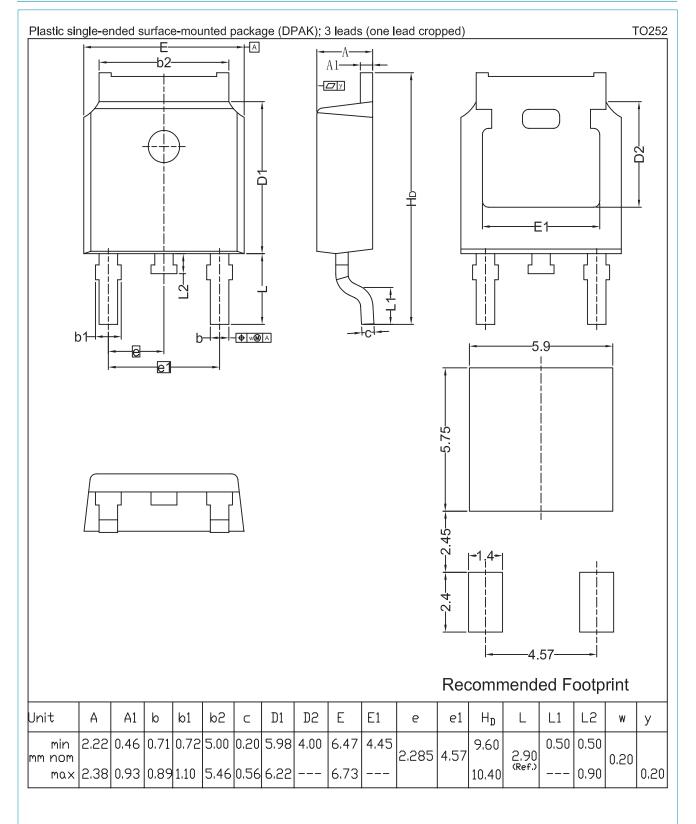
## **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · ·				
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.07	1.3	V
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	0.92	1.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 100 °C	-	-	0.4	mA
		V <sub>R</sub> = 300 V; T <sub>j</sub> = 125 °C	-	20.5	100	μA
Dynamic	characteristics					
Q <sub>r</sub>	recovered charge	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 ^\circ\text{C}; \text{ Fig. 7}$	-	55	-	nC
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	50	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	40	75	ns
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	56	100	ns
I <sub>RM</sub>	peak reverse recovery current	$I_{F} = 1 \text{ A}; V_{R} = 30 \text{ V}; dI_{F}/dt = 100 \text{ A}/\mu\text{s}; T_{j} = 25 ^{\circ}\text{C}; \frac{\text{Fig. 7}}{2}$	-	2.8	-	A
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_i = 25 \text{ °C}; Fig. 7$	-	1.9	-	A





## **11. Package outline**



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# BYV10D-600P

### Ultrafast power diode

## 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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